

Silicon Carbide (SiC) **Schottky Diode** - EliteSiC, 10 A, 650 V, D2, TO-220-2L

FFSP1065B-F085

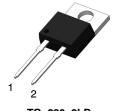
Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

Features

- Max Junction Temperature 175°C
- Avalanche Rated 49 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery / No Forward Recovery
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

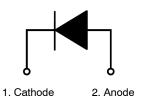
Applications

- Automotive HEV-EV Onboard Chargers
- Automotive HEV-EV DC-DC Converters

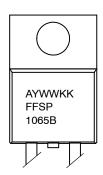


TO-220-2LD CASE 340BB

ELECTRICAL CONNECTION



MARKING DIAGRAM



YWW ΚK FFSP1065B = Specific Device Code

= Assembly Plant Code = Date Code (Year & Week) = Lot Traceability Code

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Symbol	Parameter			Unit
V _{RRM}	Peak Repetitive Reverse Voltage			V
E _{AS}	Single Pulse Avalanche Energy (Note 1)			mJ
l _F	Continuous Rectified Forward Current @ T _C < 139°C			Α
	Continuous Rectified Forward Current @ T _C < 135°C			
I _{F, Max}	Non-Repetitive Peak Forward Surge Current	T _C = 25°C, 10 μs	650	Α
		T _C = 150°C, 10 μs	570	
I _{F, SM}	Non-Repetitive Forward Surge Current	Half-Sine Pulse, $t_p = 8.3 \text{ ms}$	45	А
P _{tot}	Power Dissipation	T _C = 25°C	75	W
		T _C = 150°C	12.5	1
T_J , T_{STG}	Operating and Storage Temperature Range		-55 to +175	°C

^{1.} E_{AS} of 49 mJ is based on starting T_J = 25°C, L = 0.5 mH, I_{AS} = 14 A, V = 50 V.

THERMAL CHARACTERISTICS

S	ymbol	Parameter	Ratings	Unit
	$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2.0	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

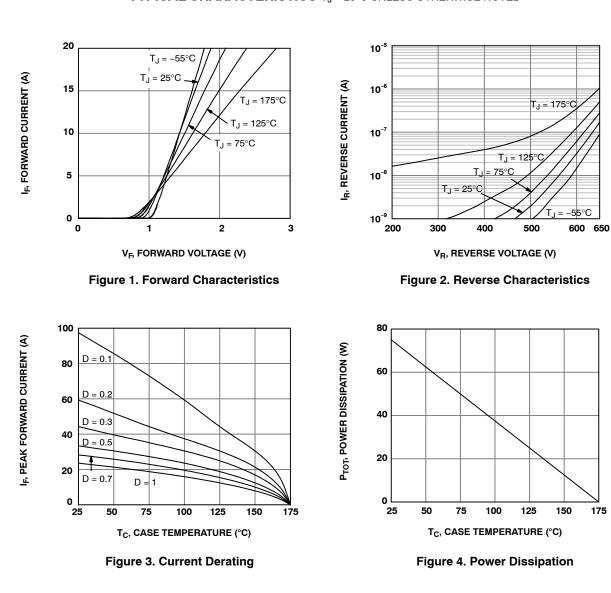
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _F	Forward Voltage	I _F = 10 A, T _C = 25°C	-	1.38	1.7	V
		I _F = 10 A, T _C = 125°C	-	1.6	2.0	
		I _F = 10 A, T _C = 175°C	-	1.72	2.4	
I _R	Reverse Current	V _R = 650 V, T _C = 25°C	-	0.5	40	μΑ
		V _R = 650 V, T _C = 125°C	-	1.0	80	
		V _R = 650 V, T _C = 175°C	-	2.0	160	
$Q_{\mathbb{C}}$	Total Capacitive Charge	V = 400 V	-	25	-	nC
С	Total Capacitance	V _R = 1 V, f = 100 kHz	-	421	-	pF
		V _R = 200 V, f = 100 kHz	-	46	-	
		$V_R = 400 \text{ V}, f = 100 \text{ kHz}$	-	35	_	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFSP1065B-F085	FFSP1065B	TO-220-2L	Tube	N/A	N/A	50 Units

TYPICAL CHARACTERISTICS TJ = 25°C UNLESS OTHERWISE NOTED



1000 100 10 0.1 10 100 650 V_R, REVERSE VOLTAGE (V)

175

40 Q_C, CAPACITANCE CHARGE (nC) 30 20 10 100 300 400 500 600 650 0 V_R, REVERSE VOLTAGE (V)

Figure 5. Capacitance Charge vs. Reverse Voltage

Figure 6. Capacitance vs. Reverse Voltage

CAPACITANCE (pF)

TYPICAL CHARACTERISTICS T_J = 25°C UNLESS OTHERWISE NOTED (CONTINUED)

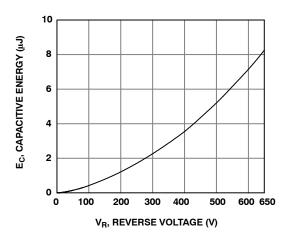


Figure 7. Capacitance Stored Energy

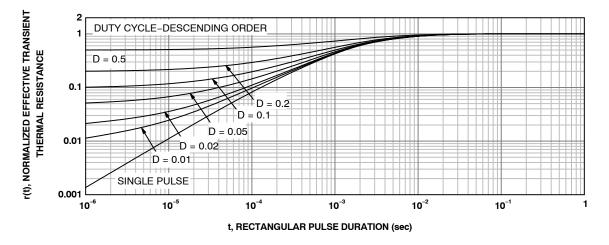


Figure 8. Junction-to-Case Transient Thermal Response Curve

TEST CIRCUIT AND WAVEFORMS

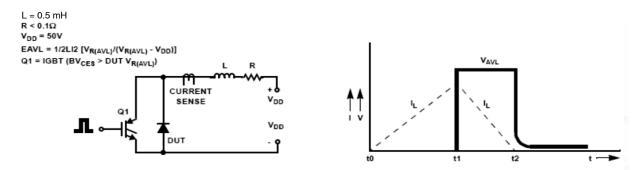
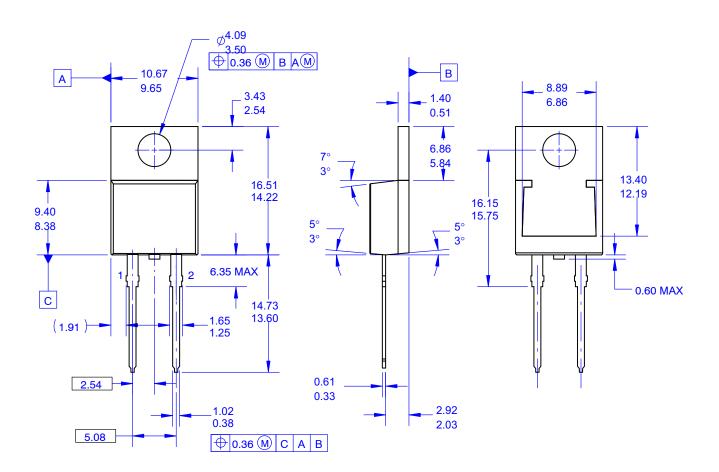
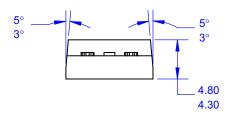


Figure 9. Unclamped Inductive Switching Test Circuit & Waveform

PACKAGE DIMENSIONS

TO-220-2LD CASE 340BB **ISSUE O**





NOTES:

- A. PACKAGE REFERENCE: JEDEC TO220,ISSUE K, VARIATION AC,DATED APRIL 2002. B. ALL DIMENSIONS ARE IN MILLIMETERS. C. DIMENSION AND TOLERANCE AS PER ASME
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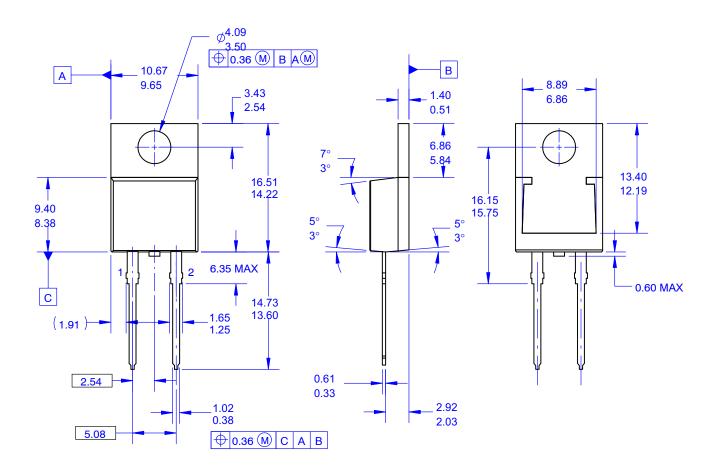
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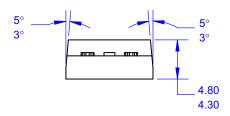
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TO-220-2LD CASE 340BB ISSUE O

DATE 31 AUG 2016





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